

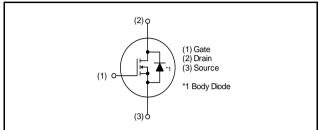
N-channel SiC power MOSFET bare die

V_{DSS}	1200V
R _{DS(on)} (Typ.)	18mΩ
I _D *1	81A

Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive

●Inner circuit



Application

- Solar inverters
- DC/DC converters
- Switch mode power supplies
- · Induction heating
- Motor drives

◆Absolute maximum ratings (T_{vj} = 25°C unless otherwise specified)

Parameter			Symbol	Value	Unit
Drain - source voltage		V_{DSS}	1200	V	
Continuous drain and	\/ \/	$T_c = 25^{\circ}C$	I _D , I _S *1	81	А
source current	$V_{GS} = V_{GS_on}$	$T_c = 100$ °C	I _D , I _S	57	А
Pulsed drain current	$V_{GS} = V_{GS_on}$	$T_c = 25^{\circ}C$	I _{D,pulse} *2	179	Α
Body diode pulsed forward current		$V_{GS} = 0 V$ $T_c = 25^{\circ}C$	I _{S,pulse} *1,*3	81	Α
Body diode surge forward current			I _{S,pulse} *1,*4	179	А
Gate - source voltage (DC)			V_{GSS}	-4 to +21	V
Gate - source surge voltage (t _{surge} < 300ns)			$V_{\rm GSS_surge}^{*5}$	-4 to +23	V
Recommended turn-on gate - source drive voltage			$V_{GS_on}^{^{*6}}$	+15 to +18	V
Recommended turn-off gate - source drive voltage			V_{GS_off}	0	V
Virtual junction temperature			T_{vj}	175	°C
Range of storage temperature			T_{stg}	-40 to +175	°C

Electrical characteristics ($T_{vj} = 25$ °C unless otherwise specified)

Parameter	Symbol	Conditions		Unit		
raiametei			Min.	Тур.	Max.	Offic
Drain - Source breakdown	W	$V_{GS} = 0 \text{ V}, I_D = 18.6\text{mA}$				V
voltage	V _{(BR)DSS}	$T_{vj} = 25^{\circ}C$	1200	-	-	V
		$V_{GS} = 0 \text{ V}, V_{DS} = 1200 \text{V}$				
Zero Gate voltage Drain current	I _{DSS}	$T_{vj} = 25^{\circ}C$	-	1	80	μΑ
Diam current		T _{vj} = 150°C	-	10	-	
Gate - Source leakage current	I _{GSS+}	$V_{GS} = +21V , V_{DS} = 0V$	-	-	100	nA
Gate - Source leakage current		$V_{GS} = -4V$, $V_{DS} = 0V$	-	-	-100	nA
Gate threshold voltage	V _{GS (th)} *7	$V_{DS} = 10V, I_D = 22.2mA$	2.8	-	4.8	V
		$V_{GS} = 18V, I_{D} = 42A$				
Static Drain - Source on - state resistance	R _{DS(on)} *8	$T_{vj} = 25^{\circ}C$	-	18.0	22.5	mΩ
S. State Politicality		T _{vj} = 150°C	-	36.0	-	
Gate input resistance	R_{G}	f = 1MHz, open drain	-	1	-	Ω

ullet Electrical characteristics ($T_{vj} = 25$ °C unless otherwise specified)

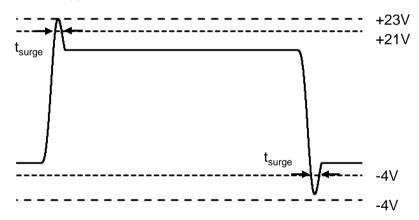
Parameter	Symbol	Conditions -	Values			Unit
Parameter	Symbol		Min.	Тур.	Max.	Offic
Transconductance	g_{fs}^{*8}	$V_{DS} = 10V, I_{D} = 42A$	-	29	-	S
Input capacitance	C _{iss}	$V_{GS} = 0V$	ı	4532	-	
Output capacitance	C _{oss}	V _{DS} = 800V	ı	129	ı	pF
Reverse transfer capacitance	C_{rss}	f = 1MHz	-	9	-	
Effective output capacitance, energy related	C _{o(er)}	$V_{GS} = 0V$ $V_{DS} = 0V \text{ to } 800V$	1	156	1	pF
Total Gate charge	Q _g *8	$V_{DS} = 800V$ $I_{D} = 42A$	ı	170	ı	
Gate - Source charge	Q _{gs} *8	V _{GS} = 18V	-	32	-	nC
Gate - Drain charge	Q _{gd} *8	See Fig. 1-1, 1-2.	ı	52	1	
Turn - on delay time	t _{d(on)} *8	$V_{DS} = 800V$ $I_{D} = 42A$	1	13	-	
Rise time	t _r *8	$V_{GS} = +18V / 0V$	ı	21	1	ns
Turn - off delay time	t _{d(off)} *8	$R_G = 3.3\Omega$, L = 250µH E_{on} includes diode	ı	50	-	113
Fall time	t _f *8	reverse recovery $L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF	ı	11	ı	
Turn - on switching loss	E _{on} *8	See Fig. 2-1, 2-2, 2-3.	-	520	-	1
Turn - off switching loss	E _{off} *8		-	142	-	μJ

●Body diode electrical characteristics (Source-Drain) (T_{vi} = 25°C unless otherwise specified)

Dorometer	Symbol	Conditions	Values			Unit
Parameter	Syllibol	Conditions	Min.	Тур.	Max.	Offic
Forward voltage	V _{SD} *8	$V_{GS} = 0V, I_D = 42A$	ı	3.3	ı	V
Reverse recovery time	t _{rr} *8	$I_F = 42A$ $V_R = 800V$	ı	12	ı	ns
Reverse recovery charge	Q _{rr} *8	$di/dt = 4700A/\mu s$	ı	252	ı	nC
Peak reverse recovery current	: I _{rrm} *8	$L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2.	-	44	-	А

^{*1} Limited by maximum T_{vi} and assumes $R_{thJC} < 0.48 \text{K/W}$. The value is based on TO-247 package.

*5 Example of acceptable V_{GS} waveform



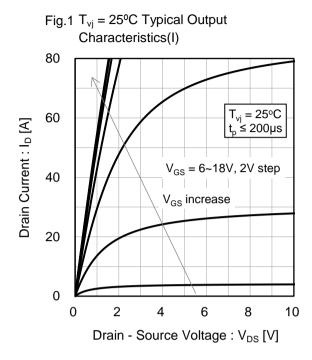
Please note especially when using driver source that $V_{\text{GSS_surge}}$ must be in the range of absolute maximum rating.

- *6 Please be advised not to use SiC-MOSFETs with V_{GS} below 10V as doing so may cause thermal runaway.
- *7 Tested after applying $V_{GS} = 21V$ for 100ms.
- *8 Pulsed

^{*2} Pulse width and duty cycle are limited by $T_{v_{i,max}}$. The value is based on TO-247 package.

^{*3} Only for body-diode, Repititive pulse, PW ≤ 1.5µs, Duty cycle ≤ 5%

^{*4} When used as a protective function, PW \leq 10 μ s



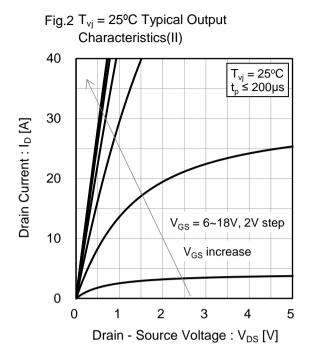
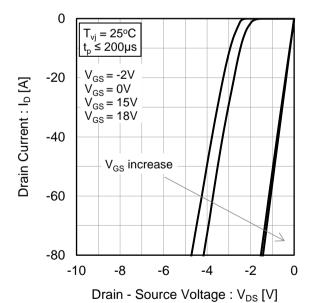
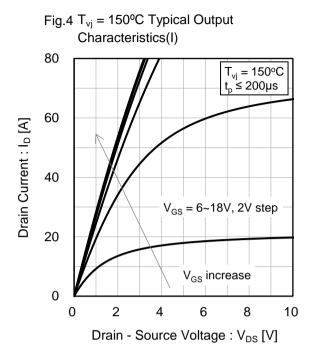
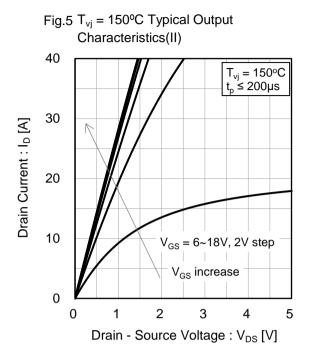
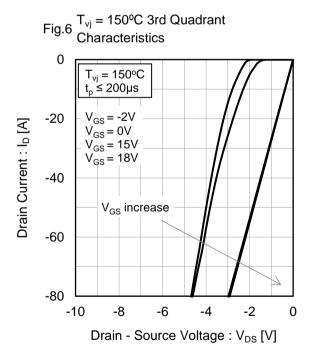


Fig.3 T_{vj} = 25°C 3rd Quadrant Characteristics









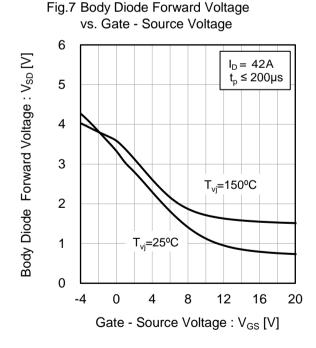


Fig.8 Typical Transfer Characteristics (I)

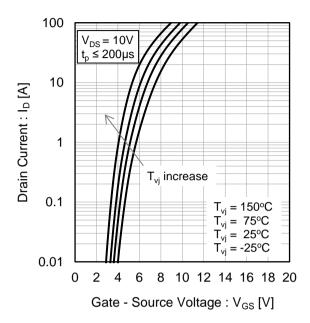


Fig.9 Typical Transfer Characteristics (II)

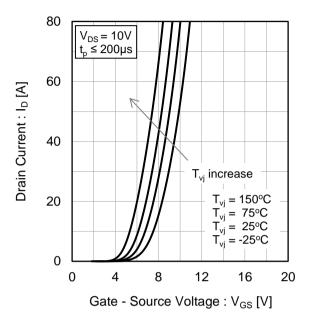


Fig.10 Gate Threshold Voltage vs. Junction Temperature

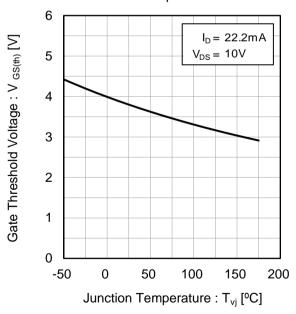


Fig.11 Transconductance vs. Drain Current

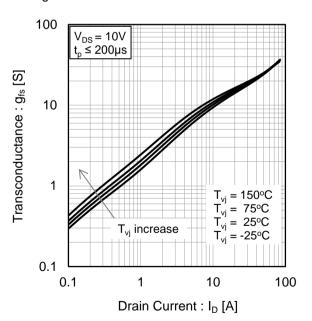


Fig.12 Static Drain - Source On - State Resistance vs. Gate - Source Voltage

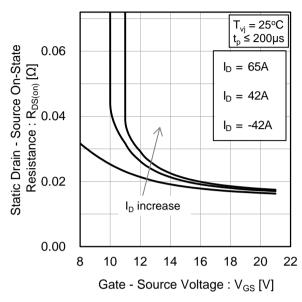


Fig.13 Static Drain - Source On - State
Resistance vs. Junction Temperature

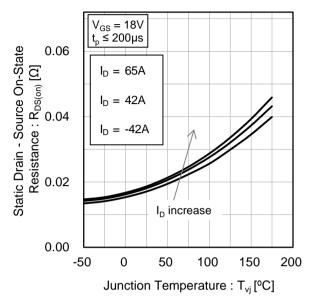


Fig.14 Static Drain - Source On - State Resistance vs. Drain Current

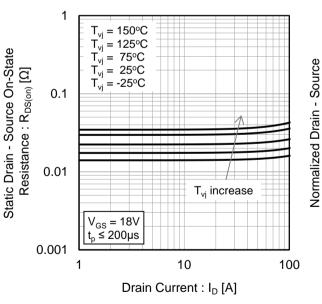
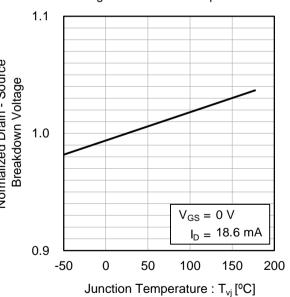


Fig.15 Normalized Drain - Source Breakdown Voltage vs. Junction Temperature



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Fig.16 Typical Capacitance vs. Drain - Source Voltage 10000 Ciss 1000 Capacitance: C [pF] 100 10 T_{vj} = 25°C f = 1MHz C_{rss} 0.1 1 10 100 1000 Drain - Source Voltage: V_{DS} [V]

Fig.17 Coss Stored Energy 60 $T_{vj} = 25^{\circ}C$ 50 Coss Stored Energy: Eoss [µJ] 40 30 20 10 0 200 400 600 800 0 Drain - Source Voltage : V_{DS} [V]

Fig.18 Dynamic Input Characteristics

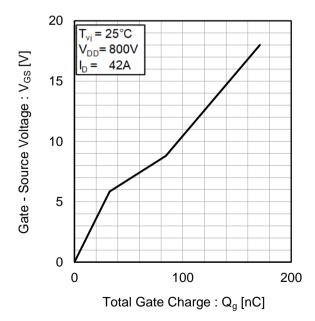


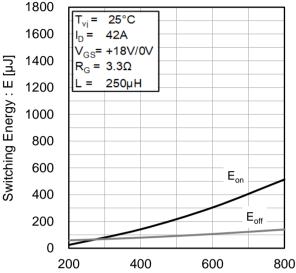
Fig.19 Typical Switching Time

vs. External Gate Resistance

250 $T_{vj} = 25^{\circ}C$ $I_D = 42A$ $V_{DD} = 800V$ $V_{GS} = +18V/0V$ $L = 250\mu H$ 150

50 $t_{d(onf)}$

Fig.20 Typical Switching Loss vs. Drain - Source Voltage



External Gate Resistance : $R_G[\Omega]$

10

15

20

Drain - Source Voltage : V_{DS} [V]

Fig.21 Typical Switching Loss vs. Drain Current

0

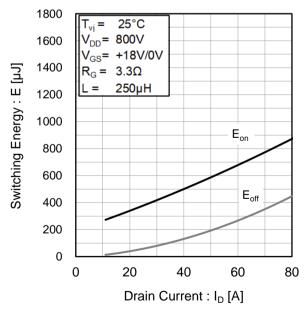
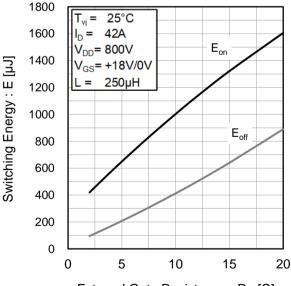


Fig.22 Typical Switching Loss vs. External Gate Resistance



External Gate Resistance : R_G [Ω]

•Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

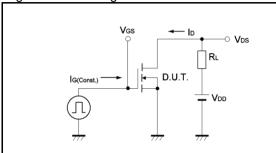


Fig.2-1 Switching Characteristics Measurement Circuit

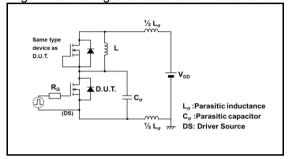


Fig.2-3 Waveforms for Switching Energy Loss

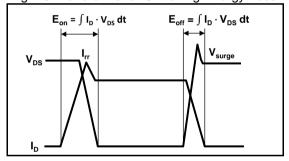


Fig.3-1 Reverse Recovery Time Measurement Circuit

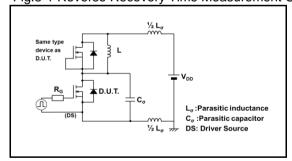


Fig.1-2 Gate Charge Waveform

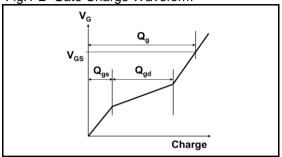


Fig.2-2 Waveforms for Switching Time

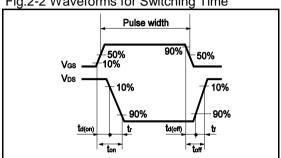
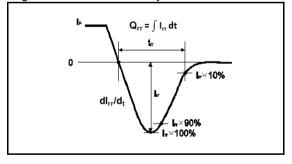


Fig.3-2 Reverse Recovery Waveform

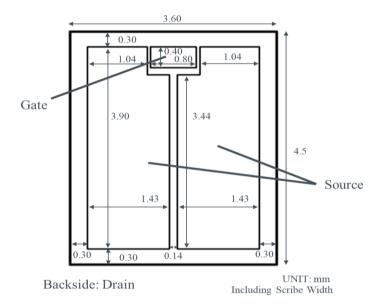


Mechanical Parameters

Die Size	3.60 mm x 4.50 mm (Including Scribe Width)
Thickness	150 ± 15 μm
Source Pad Size	See Pad Layout.
Gate Pad Size	0.80 mm x 0.40 mm

Wafer Size	150 mm
Topside Metallization	AlCu
Backside Metallization	Ti-Ni(1.2μm)-Au(0.07μm)
Passivation	Polyimide

●Pad Layout



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